

Description

The AP8205A-21 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

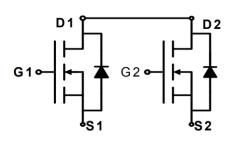
V_{DS}=20V I_D =6.5A

 $R_{DS(ON)} < 25m\Omega$ @ $V_{GS}=10V$ (Type: $19m\Omega$)

Application

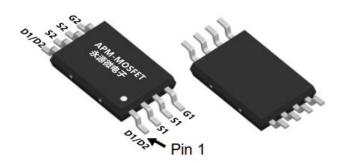
Lithium battery protection

Mobile phone fast charging





TSSOP8
Top View Bottom View



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP8205A-21	TSSOP-8	8205A XXX YYYY	5000

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	20	V
VGS	Gate-Source Voltage	±12	V
ID@TA=25°C	Continuous Drain Current1	6.5	А
ID@TA=70°C	Continuous Drain Current1	4.8	А
IDM	Pulsed Drain Current2	24	А
PD@TA=25°C	Total Power Dissipation3	1.5	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R _θ JA	Thermal Resistance Junction-ambient ¹	85	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	20	22		V
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =5A		19	25	0
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =2.5V , I _D =4A		24	40	mΩ
VGS(th)	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	0.5	0.7	1.2	٧
IDSS	Drain-Source Leakage Current	V _{DS} =16V , V _{GS} =0V , T _J =25°C			1	uA
IGSS	Gate-Source Leakage Current	V _{GS} =±8V , V _{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =3.5A		20		S
Qg	Total Gate Charge (4.5V)	V _{DS} =15V , V _{GS} =4.5V , I _D =7A		11.4		
Qgs	Gate-Source Charge			1.6		nC
Qgd	Gate-Drain Charge			2.9		
Td(on)	Turn-On Delay Time			5		
Tr	Rise Time	V_{DD} =10V , V_{GS} =4.5V ,		32.4		
Td(off)	Turn-Off Delay Time	R _G =3.3 I _D =5A		28		ns
Tf	Fall Time			9		
Ciss	Input Capacitance			863		
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		87		pF
Crss	Reverse Transfer Capacitance			71		
ls	Continuous Source Current ^{1,4}	V _G =V _D =0V , Force Current			6	Α
VsD	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	V

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2. The data tested by pulsed , pulse width $\, \leqq \, 300 us$, duty cycle $\, \leqq \, 2\%$
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

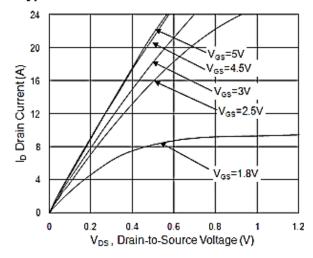


Fig.1 Typical Output Characteristics

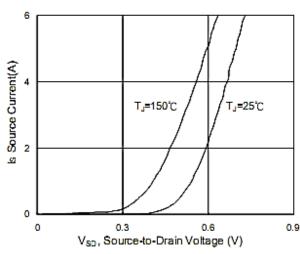


Fig.3 Forward Characteristics of Reverse

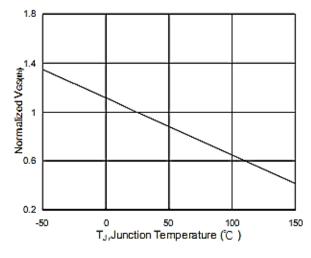


Fig.5 V_{GS(th)} vs. T_J

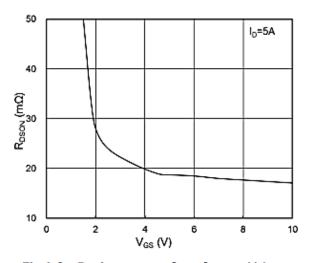


Fig.2 On-Resistance vs. Gate-Source Voltage

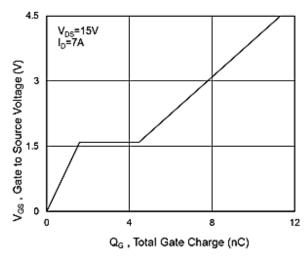


Fig.4 Gate-Charge Characteristics

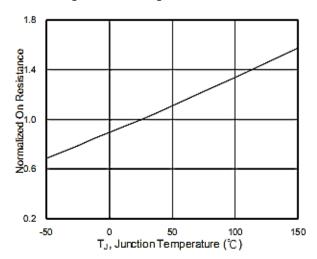
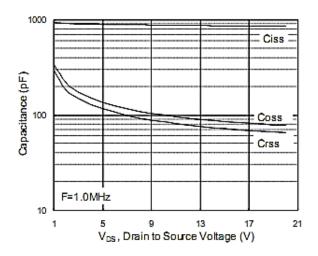


Fig.6 Normalized RDSON vs. TJ







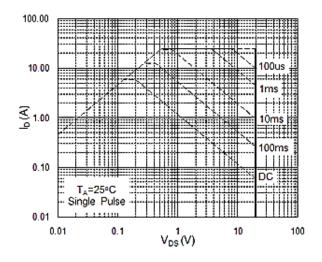


Fig.7 Capacitance

Fig.8 Safe Operating Area

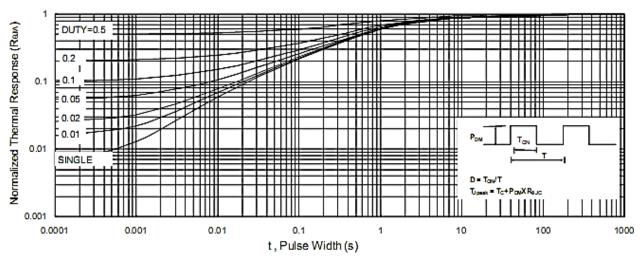
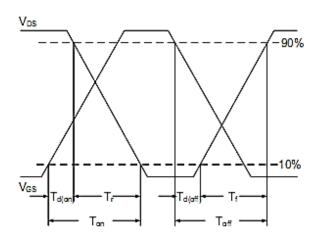
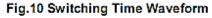


Fig.9 Normalized Maximum Transient Thermal Impedance





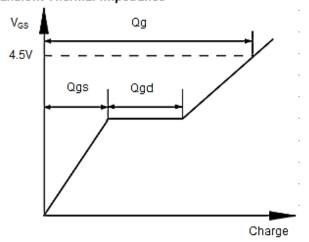
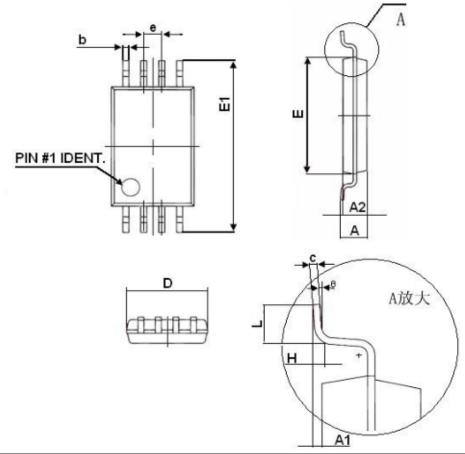


Fig.11 Gate Charge Waveform



Package Mechanical Data



0	Dimensions In Millimeters		
Symbol	Min	Max	
D	2.900	3.100	
E	4.300	4.500	
b	0.190	0.300	
С	0.090	0.200	
E1	6.250	6.550	
Α		1.100	
A2	0.800	1.000	
A1	0.020	0.150	
е	0.65(BSC)		
L	0.500	0.700	
Н	0.25(TYP)		
Θ	1°	7°	



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Edition	Date	Change
Rve1.0	2018/1/31	Initial release
Rve1.1	2022/1/03	Reduce RDS(on)

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